DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE)

(Under 37 CFR § 1.63; with Power of Attorney)

FROMMER LAWRENCE & HAUG LLP

FLH File No. 450100-04722

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention ENTITLED:

DATA TRANSFORM METHOD AND APPA	RATUS, DATA PROCE	SSING METHOD AND APP	ARATUS, AND PROGRAM
the specification of which			
X is attached hereto.			
was filed on	as Application Se	erial No.	
with amendment(s) through		(if applicable,	give dates).
I hereby state that I have reviewed			
the claims, as amended by any amendment refe I acknowledge the duty to disclose t to be material to patentability as defined i I hereby claim foreign priority bene	rred to above. to the United States Pa n Title 37, Code of Fe efits under Title 35, U	ntent and Trademark Office a deral Regulations, Sec. 1.5 United States Code, § 119 o	all information known to me 66. f any foreign application(s)
for patent or inventor's certificate listed inventor's certificate having a filing date			
Prior Foreign Application(s) [lis	• •	•	Priority Claimed:
Number: Coun	• •	led (Day/Month/Year):	Yes No
	pan	30 August 2002	x –
I hereby claim the benefit under Tit below and, insofar as the subject matter of States application in the manner provided by duty to disclose to the United States Patent patentability as defined in Title 37, Code of date of the prior application and the nation	each of the claims of the first paragraph o and Trademark Office of Federal Regulations, al or PCT internationa	this application is not dis f Title 35, United States (all information known to me Sec. 1.56, which became a l filing date of this appl	sclosed in the prior United Code § 112, I acknowledge the e to be material to vailable between the filing
Prior U.S. Application(s) [list add	• • •	· · ·	-b d d
Appln. Ser. Number: Filed (Day/Mo	ontn/year):	Status (patented, pending,	abandoned):
I hereby appoint <u>WILLIAM S. FROMMER</u> or their duly appointed associate, my attorn application, to make alterations and amendme receive the Patent, and to transact all busi therewith, and specify that all communication address: <u>WILLIAM S. FROMMER</u> , Esq. c/o FROMMER LAWRENCE & HAUG LLP	neys, with full power o ents therein, to file c iness in the Patent and	f substitution and revocat ontinuation and divisional Trademark Office and in th	ion, to prosecute this applications thereof, to ne Courts in connection ne following correspondence
745 Fifth Avenue		to the attention of:	
New York, New York 10151		WILLIAM S. FROMMER	—
I hereby declare that all statements information and belief are believed to be to willful false statements and the like so mad Title 18 of the United States Code and that or any patent issued thereon. INVENTOR(S):	rue; and further that t de are punishable by fi	hese statements were made on the continuous may jeopardize the	with the knowledge that n, under Section 1001 of
Signature:Full name of sole or first inventor:	Naoya HANEDA	Date:	· · · · · · · · · · · · · · · · · · ·
Residence:	Tokyo, Japan		
Citizenship:	Japan		
Signature:		Date:	
Full name of 2nd joint inventor (if any): Residence: Citizenship:	Kyoya TSUTSUI Kanagawa, Japan Japan		
Signature:		Date:	
Full name of 3rd joint inventor (if any): Residence: Citizenship:			
[Similarly list additional inventors on sepa Post Office Address(es) of inventor(s): [if all inventors have the same post office	·	Sony Corporation 7-35 Kitashinagawa 6-chome	:
Note: A post office address must be provide	ed for each inventor.	Shinagawa-Ku, Tokyo 141,	Japan